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Attorney Docket No.: 01CON211P

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: **Kar Roy, et al.**

Serial No.: 10/073,751

Filed: February 9, 2002

For: **Method for Fabricating a Metal
Resistor in an IC Chip and Related
Structure**

Art Unit: 2815

Examiner: Chu, Chris C.

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RESPONSE TO FINAL OFFICE ACTION

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P.O. Box 1450
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Dear Sir/Madam:

This is in response to the *Final Office Action* dated July 14, 2004 in the above-referenced patent application. Please enter and consider the following remarks.

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